

IN THE CLAIMS

Please amend Claim 1 as shown in marked up form as follows:

1. (Currently Amended) A stamp for use in a lithographic process, said stamp comprising:

a permeable stamp body with a first side and a second side, said first and second sides being opposed;

a structured printing face at said first side;

a reservoir for a liquid at said second side; and

a permeable carrier body with a higher rigidity constant than the permeable stamp body connecting said permeable stamp body and said reservoir,

wherein said liquid is directly transported from said reservoir through said permeable carrier body and said permeable stamp body to said structured printing face during use.

2. (Previously Presented) The stamp of claim 1, wherein said

permeable carrier body has a first side and a second, opposed side, with said permeable stamp body at said first side and said reservoir at said second side, said permeable carrier body having channels, at least a portion of which extend from said first side to said second side of said permeable carrier body.

3. (Previously Presented) The stamp of claim 2, wherein said first side and said second side of said permeable stamp body lie at a distance from one another, and said channels at said first side of said permeable carrier body each have a diameter which is smaller than said distance between said first side and said second side of said permeable stamp body.

4. (Previously Presented) The stamp of claim 1, wherein said permeable carrier body has a porous material.

5. (Previously Presented) The stamp of claim 1, wherein said reservoir has a porous material.

6. (Previously Presented) The stamp of claim 1, wherein said stamp is cylindrical in shape, with said structured printing face forming an outer cylinder shell.

7. (Previously Presented) A method of manufacturing an electronic component, comprising the steps of:

patterning a surface of a substrate by means of a stamp, said stamp having a structured printed face for use in a lithographic process; and

bringing said stamp into contact with said substrate such that a liquid cooperative with said structured printing face is transferred to a surface of said substrate,

wherein said stamp of claim 1 is used therein.

8. (Previously Presented) The method of claim 7, wherein said stamp is cylindrical in shape, and said stamp is rotated when being applied to the substrate such that the entire printing face of the stamp is rolled over the substrate.

9. (Previously Presented) An apparatus for providing at least one patterned layer on a substrate, which apparatus is provided with a stamp of claim 1.